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CENTRAL FAX CENTER
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Application No. 10/519,046
Filed: August 19, 2005
TC Art Unit: 4145
Confirmation No.: 6619

AMENDMENTS TO THE SPECIFICATION

Please replace the paragraph at page 24, lines 3-20 with the following replacement paragraph:

An object is to provide a molded product, which has dielectric properties that the conventional liquid crystal polyester resin has not realized, and simultaneously which keeps a heat resistance such as solder reflow of a liquid crystal polyester, and which is used in information and telecommunications equipment employed in high frequency band regions such as microwaves and millimeter waves. A molded product of a wholly aromatic liquid crystal polyester resin composition which has having a dielectric constant of 3.0 or less and a dielectric dissipation factor of 0.04 or less and which is obtained by an injection molding of a composition comprising 90 to 45 percent by weight of the wholly aromatic liquid crystal polyester having a melting point of 320C or more, 10 to 40 percent by weight of an inorganic spherical hollow material having an aspect ratio of 2 or less, and 0 to 15 percent by weight (100 percent by weight in total) of an inorganic filler having an aspect ratio of 4 or more. The molded product of the present invention has dielectric properties suitable for

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information and telecommunications equipment, and is excellent in solder heat resistance, processability, and dimensional stability. ~~so that~~ ~~T~~the molded product is advantageous as a substrate material for use in information and telecommunications equipment such as a cellular mobile phone and as a fixing/holding or ~~a holding~~ member of a transmitter-receiver element.